

SPECIFICATION FOR APPROVAL

Customer :			超利維	
Customer P/N:				
Drawing No :	ving No : TE1-820061			
Quantity:	X	Pcs.	Date :	2018/02/06
Chilisin P/N:	MHCH252010A-R24M-AU			

Automotive Grade Inductor

Holegen Free RoHS Compliant REACH Compliant Lead Free Solders AEC-Q200

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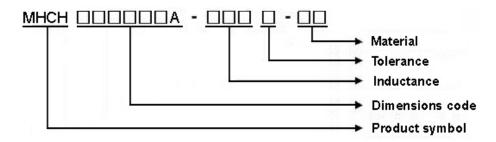
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Approved by 鍾瑞民 Jacky.Chung

- 1 Scope: This specification applies to Molding power inductors
- 2 Part Numbering:



3 Rating:

Operating Temperature: $-4.0 \,^{\circ}\text{C} \sim 1.2.5 \,^{\circ}\text{C}$ (Including self - temperature rise)

Storage Temperature: $-4.0 \,^{\circ}\text{C} \sim 1.2.5 \,^{\circ}\text{C}$ (after PCB)

 $-5\,^{\circ}\mathrm{C} \sim 3\,\,5\,^{\circ}\mathrm{C}$, Humidity $4\,\,5\,\% \sim 8\,\,5\,\%$ (before PCB)

4 Marking:

No Marking

5 Standard Testing Condition

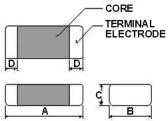
	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35°ℂ)	20±2 ℃
Humidity	Ordinary Humidity(25 to 85% RH)	60 to 70 % RH



ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

MHCH252010A Series Specification

6 Configuration and Dimensions:



Dimensions in mm				
TYPE	MHCH252010A			
Α	2.5±0.3			
В	2.0±0.3			
С	1.0 Max.			
D	0.6±0.3			

7 Electrical Characteristics:

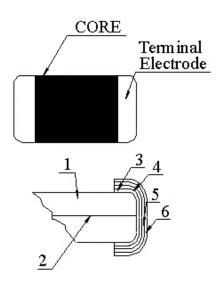
Part No.	Inductance (uH)	Tolerance (±%)	Test Freq.	Irms(A) Max.(Typ)	Isat(A) Max.(Typ)	RDC(mΩ) Max.(Typ)
MHCH252010A-R24M-AU	0.24	20	2MHz,0.2V	5.5(6.5)	8.0(9.5)	18(13)

NOTE

- 1.Operating temperature range $-4.0\,^{\circ}\text{C} \sim 1.2.5\,^{\circ}\text{C}$ (Including self temperature rise)
- 2.Isat for Inductance drop 30% from its value without current.
- 3.Irms for a 40°C temprature rise from 25°C ambient.
- 4.All test data is referenced to 25°C ambient



8 MHCH252010A Series 8.1 Construction:



8.2 Material List:

NO	Part	Description
1	Core	Metal Powder
2	Wire	Copper wire
3	Sputter/Plating	Cu
4	Silver Electrode	Ag
5	Plating	Ni
6	Plating	Sn



AEC-Q200

Reliability of molding power inductors

1-1	l.Med	chanical	Performance
		,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	i ci ioi illalice

No	Item	Specification	Test Method
1-1-1	Board Flex	The forces applied on the right	Refer to AEC-Q200-005
		conditions must not damage	Test device shall be soldered on the substrate
		the terminal electrode and the	Substrate Dimension: 100x40x1.6mm
		metal body	Deflection: 2.0mm
		,	Keeping Time: 60sec
1-1-2	Terminal Strength Test	Appearance: No damage	Refer AEC-Q200-006
	· ·		Soldered on PCB for testing as fig.
			Force: 1.8kg
			Keeping Time: 60 seconds.
			Mounting Pad
1-1-3	Solder ability	The electrodes shall be at	Refer to J-STD-002
		least 95% covered with new	Pre-heating: 150°C, 1min
		solder coating	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)
			Solder Temperature: 245±5°C (Pb-Free)
			Immersion Time: 4±1sec
1-1-4	Resistance to Soldering Heat	Appearance: No damage	Refer to MIL-STD-202 Method 210
		Inductance: within ±20% of	Pre-heating: 150°C, 1min
		initial value	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)
			Solder Temperature: 260±5°C
			Immersion Time: 10±1sec
1-1-5	Resistance to Solvents	There must be no change in	Inductors must withstand 6 minutes of alcohol or water.
		appearance or obliteration of	
		marking.	
1-1-6	Mechanical Shock	The forces applied on the right	Pulse shape: Half-sine waveform
		conditions must not damage	Impact acceleration: 100 g
		the terminal electrode and the	Pulse duration: 6 ms
		ferrite.	Number of shocks: 18 shocks (3 shocks for each face)
			Orientation: Bottom, top, left, right, front and rear faces
1-1-7	Vibration	Appearance: No damage	Refer MIL-STD-202 Method 204
		Inductance change shall be	Vibration waveform: Sine waveform
		within ±20%.	Vibration frequency: 10Hz~2000Hz
			Vibration acceleration: 5g
			Sweep rate: 0.764386otcave/minute
			Duration of test: 12 cycles each of 3 orientations,
			20 minutes for each cycle
			Vibration axes: X, Y & Z

1-2.Environmental Performance

No	ltem	Specification	Test Method
1-2-1	Temperature Cycle	Appearance: No damage	Refer to JESD Method JA-104
		Inductance:within±30% of	Total cycles: 1000 cycles
		initial value	Temperature Cycling Test Conditions : -40 to +125 $^{\circ}\mathrm{C}$
			Soak Mode Condition: 30 minutes
			Measured after exposure in the room condition for 24hrs
1-2-2	Operational Life		Temperature: 125±2°C
			Appliend Current : Rated Current
			Time: 1000± 24 hrs
			Measured after exposure in the room condition for 24hrs
1-2-2	Biased Humidity Resistance		Refer to MIL-STD-202 Method 103

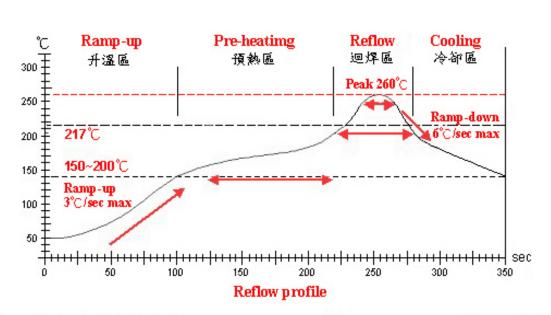


ISO 9 0 0 1 & ISO 14 0 0 1 & TS 16 9 49 CHILISIN FLECTRONICS CORP

MHCH252010A Series Specification

AEC-Q200

		Temperature: 85±2°C
		Relative Humidity:85% / Time: 1000hrs
		Measured after exposure in the room condition for 24hrs
1-2-3	High	Refer to MIL-STD-202 Method 108
	Temperature Exposure	Temperature: 125±3℃
	(Storage)	Time: 1000hrs
		Measured after exposure in the room condition for 24hrs



Lead-Free(LF) 標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升溫區 Ramp-up	預熱區 Pre-heatimg	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
温度範圍 Temp.scope	R.T. ~150°C	150°C ~ 200°C	217℃	260±5°C	Peak Temp. ~ 150°C
標準時間 Time spec.	_	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	_
實際時間 Time result	<u> </u>	75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	_

NOTE:

- 1. Re-flow possible times : within 2 times
- 2. Nitrogen adopted is recommended while in re-flow



10 Packaging:

10.1 Packaging -Cover Tape

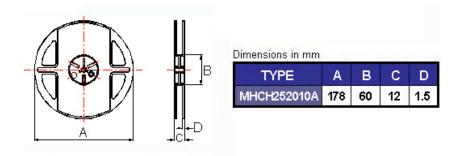
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



10.2 Packaging Quantity

TYPE	PCS/REEL
MHCH252010A	3000

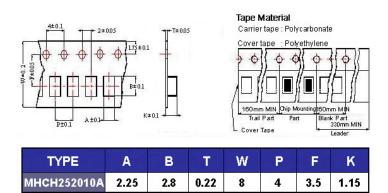
10.3 Reel Dimensions



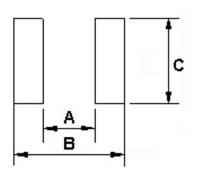


10 Packaging:

10.4 Tape Dimensions in mm



11 Recommended Land Pattern:



Dimensions in mm

TYPE	Α	В	O
MHCH252010A	1.2	2.8	2.3

12 Note:

- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose,under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5. After manufacturing process, there might be slight irregular shape on the edge of the products, and it's a normal phenomenon that can be neglectable.
- 6.The moisture sensitivity level (MSL) of products is classified as level 1.



13 Graph: MHCH252010A-R24M-AU

